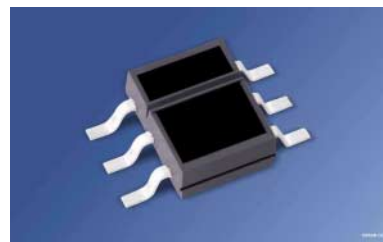


Reflexlichtschranke mit Schmitt-Trigger Reflective Interrupter with Schmitt-Trigger Lead (Pb) Free Product - RoHS Compliant

SFH 9240



Wesentliche Merkmale

- IR-GaAs-Lumineszenzdiode in Kombination mit einem Schmitt-Trigger IC
- SFH 9240: Output active low
- Tageslichtsperrfilter
- Einschaltstrom: typ. 3 mA
- Sender und Empfänger galvanisch getrennt
- Vorbehandlung nach JEDEC Level 4

Anwendungen

- Optischer Schalter
- Pulsformer
- Zähler

Features

- IR-GaAs-emitter in combination with a Schmitt-Trigger IC
- SFH 9240: Output active low
- Daylight cut-off filter
- Threshold current: typ. 3 mA
- Emitter and detector electrically isolated
- Preconditioning acc. to JEDEC Level 4

Applications

- Optical threshold switch
- Pulseformer
- Counter

Typ Type	Bestellnummer Ordering Code	$I_{F,ON}$ [mA] ($V_{CC} = 5\text{ V}$, $d = 1\text{ mm}$ Kodak neutral white test card with 90% reflection)
SFH 9240	Q65110A2714	3 (< 10)

Grenzwerte ($T_A = 25\text{ °C}$)**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Sender (GaAs-Diode)			
Emitter (GaAs diode)			
Sperrspannung Reverse voltage	V_R	5	V
Vorwärtsgleichstrom Forward current	I_F	50	mA
Stoßstrom ($t_p \leq 10\ \mu\text{s}$) Surge current ($t_p \leq 10\ \mu\text{s}$)	I_{FSM}	1.5	A
Verlustleistung Power dissipation	P_{tot}	80	mW

Empfänger (Schmitt-Trigger IC)**Detector (Schmitt-Trigger IC)**

Versorgungsspannung Supply voltage	V_{CC}	- 0.5 ... + 20	V
Ausgangsspannung Output voltage	V_O	- 0.5 ... + 20	V
Ausgangsstrom Output current ($T_A = 25\text{ °C}$)	I_O	50	mA
Verlustleistung Power dissipation	P_{tot}	175	mW

Reflexlichtschranke**Light Reflection Switch**

Betriebs- und Lagertemperatur Operating and storage temperature range	T_{op}, T_{stg}	- 40 ... + 100	°C
Verlustleistung Power dissipation	P_{tot}	150	mW

Kennwerte ($T_A = 25\text{ °C}$)

Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
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Sender (GaAs-Diode)**Emitter** (GaAs diode)

Durchlassspannung Forward voltage $I_F = 50\text{ mA}$	V_F	1.25 (≤ 1.65)	V
Sperrstrom Reverse current $V_R = 5\text{ V}$	I_R	0.01 (≤ 1)	μA
Kapazität Capacitance $V_R = 0\text{ V}, f = 1\text{ MHz}$	C_O	25	pF
Wärmewiderstand (Montage auf PC-Board mit > 5 mm ² Padgröße) Thermal resistance (mounting on pcb with > 5 mm ² pad size)	R_{thJA}	270	K/W

Empfänger (Schmitt-Trigger IC) (wenn nicht anders angegeben, $V_{CC} = 5\text{ V}$)**Detector** (Schmitt-Trigger IC) (unless otherwise specified, $V_{CC} = 5\text{ V}$)

Ausgangsspannung „high“ Output voltage “high” $I_O = 0$	V_{OH}	$V_{CC} (> 4.0)$	V
Ausgangsspannung „low“ Output voltage “low” $I_O = 16\text{ mA}$	V_{OL}	0.15 (< 0.4)	V
Stromaufnahme Supply current $V_{CC} = 5\text{ V}$ $V_{CC} = 18\text{ V}$	I_{CC}	3.3 (< 5) 5.0	mA
Anstiegszeit 10% bis 90% Rise time 10% to 90% $R_L = 280\ \Omega, I_F = 20\text{ mA}$	t_r	20	ns
Abfallzeit 90% bis 10% Fall time 90% to 10% $R_L = 280\ \Omega, I_F = 20\text{ mA}$	t_f	10	ns

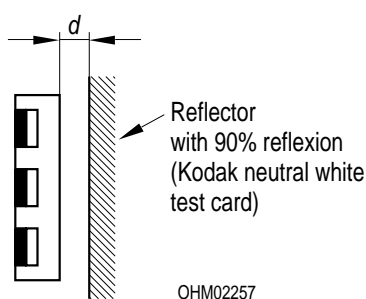
Kennwerte ($T_A = 25\text{ °C}$)

Characteristics (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Ausgangsverzögerungszeit Propagation delay time "ON" $R_L = 280\ \Omega$, $I_F = 20\text{ mA}$	t_{ON}	1	μs
Ausgangsverzögerungszeit Propagation delay time "OFF" $R_L = 280\ \Omega$, $I_F = 20\text{ mA}$	t_{OFF}	2	μs

Reflexlichtschranke**Light Reflection Switch**

Schaltsschwelle Threshold current, Kodak neutral white test card with 90% reflection $V_{CC} = 5\text{ V}$, $d = 1\text{ mm}$	$I_{F, ON}$	3 (< 10)	mA
Hysterese Hysteresis	$I_{F, OFF} / I_{F, ON}$	0.6 (0.5 ... 0.9)	—

**Zulässiger Arbeitsbereich****Operating Conditions**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Versorgungsspannung Supply voltage	V_{CC}	4 ... 18	V
Ausgangsstrom Output current	I_O	< 16	mA

Zur Stabilisierung der Versorgung wird ein Stützkondensator (angeschlossen zwischen V_{CC} und GND) von typ. $0.1\ \mu\text{F}$ empfohlen.

A bypass capacitor, $0.1\ \mu\text{F}$ typical, connected between V_{CC} and GND is recommended in order to stabilize power supply line.

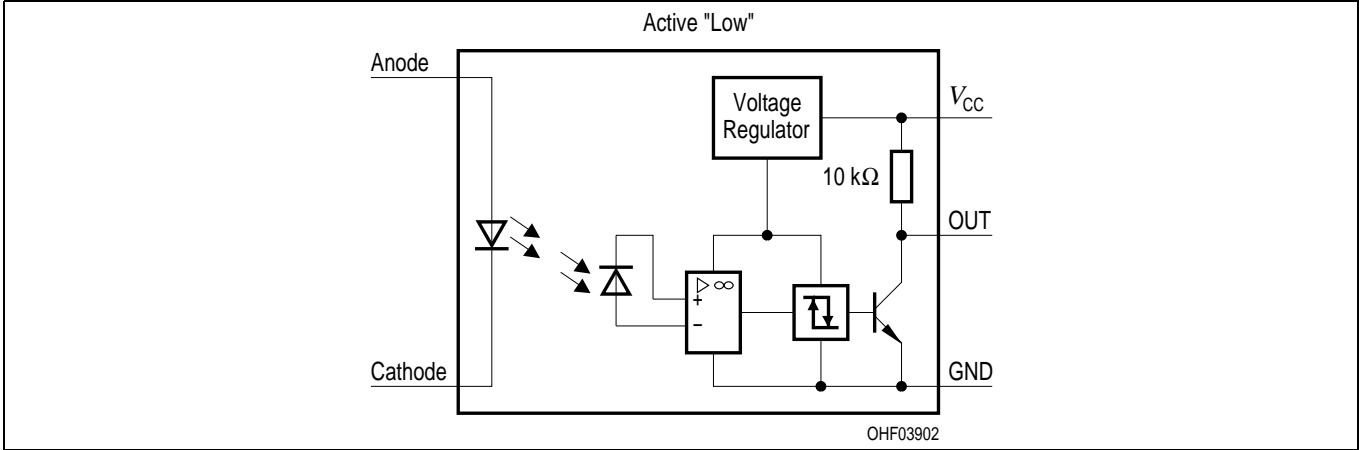


Figure 1 Block Diagram

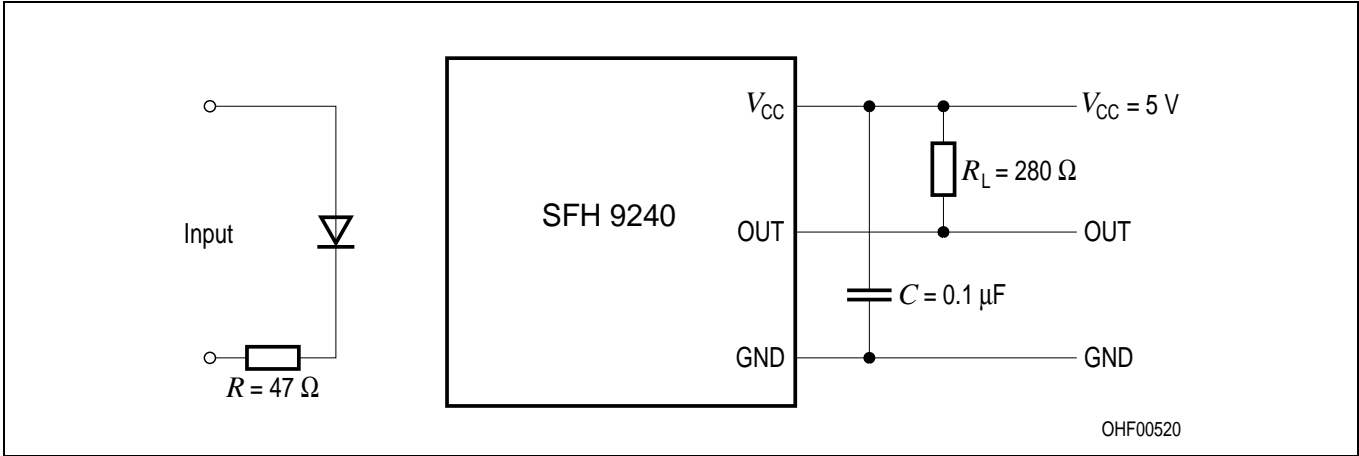


Figure 2 Test Circuit for Switching and Response Time

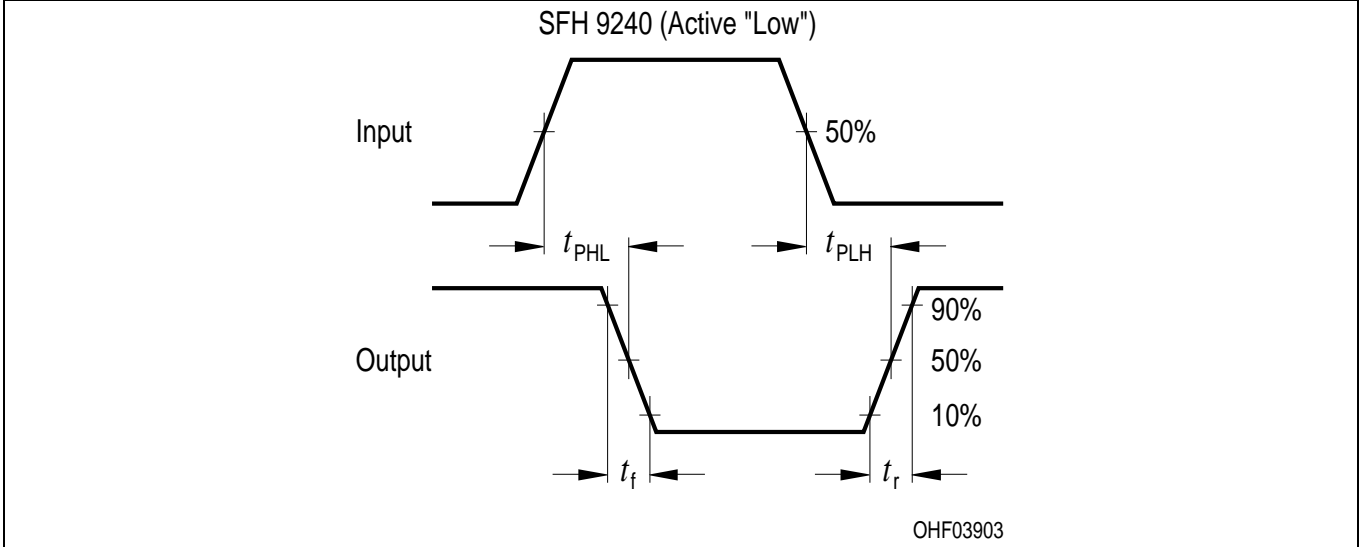
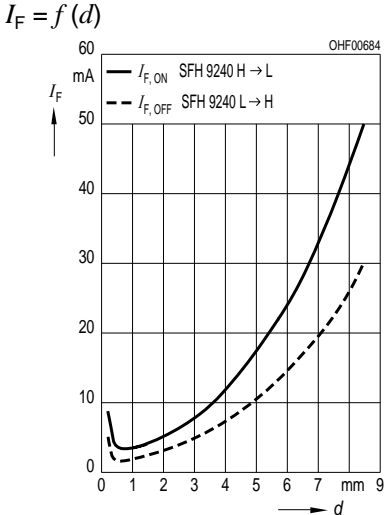
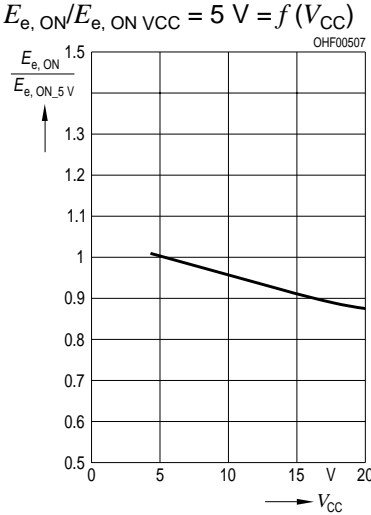


Figure 3 Switching Time Definitions

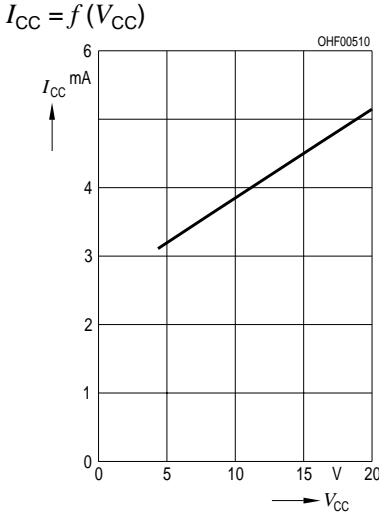
Threshold Current vs. Distance



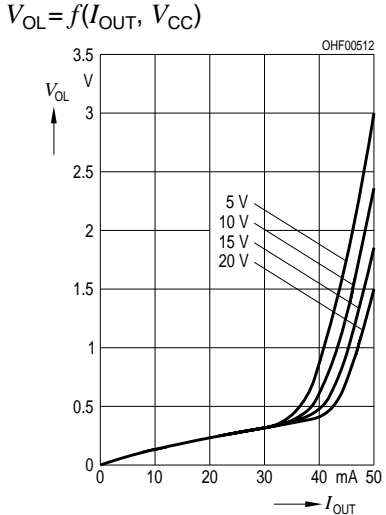
Relative Threshold



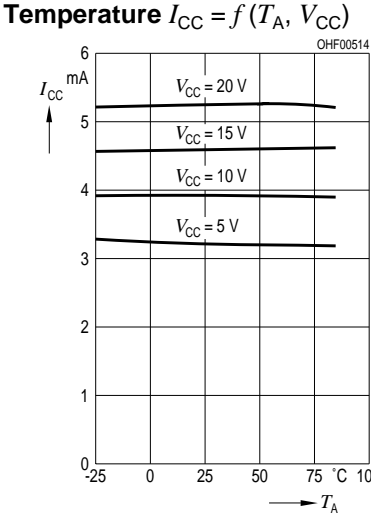
Supply Current



Output Voltage

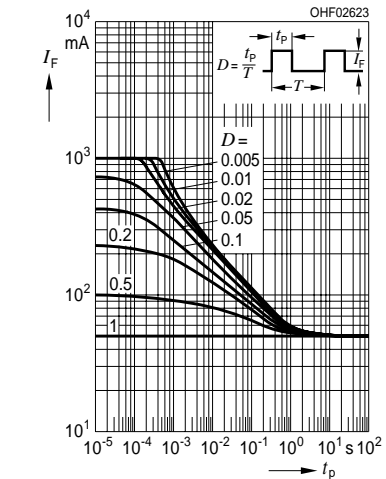


Supply Current vs. Ambient Temperature



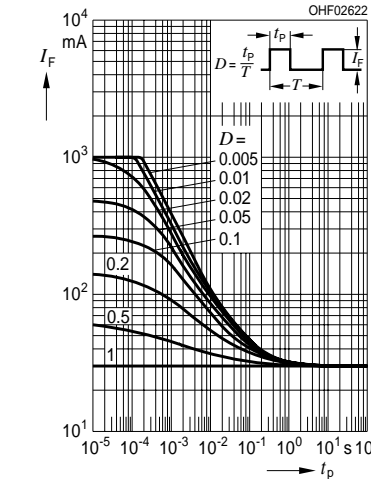
Perm. Pulse Handling Capability

$I_F = f(t_p)$, Duty cycle $D =$ parameter, $T_A = 25^\circ C$

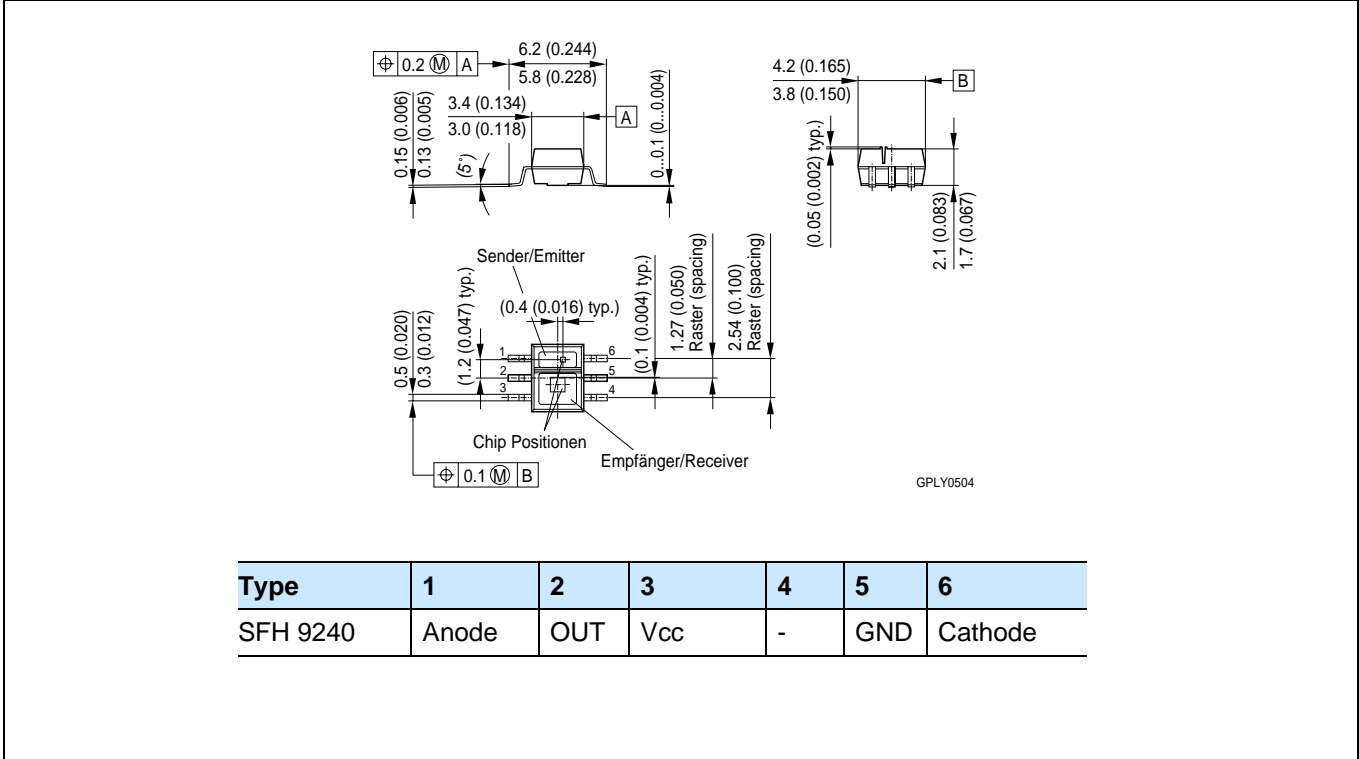


Perm. Pulse Handling Capability

$I_F = f(t_p)$, Duty cycle $D =$ parameter, $T_A = 85^\circ C$

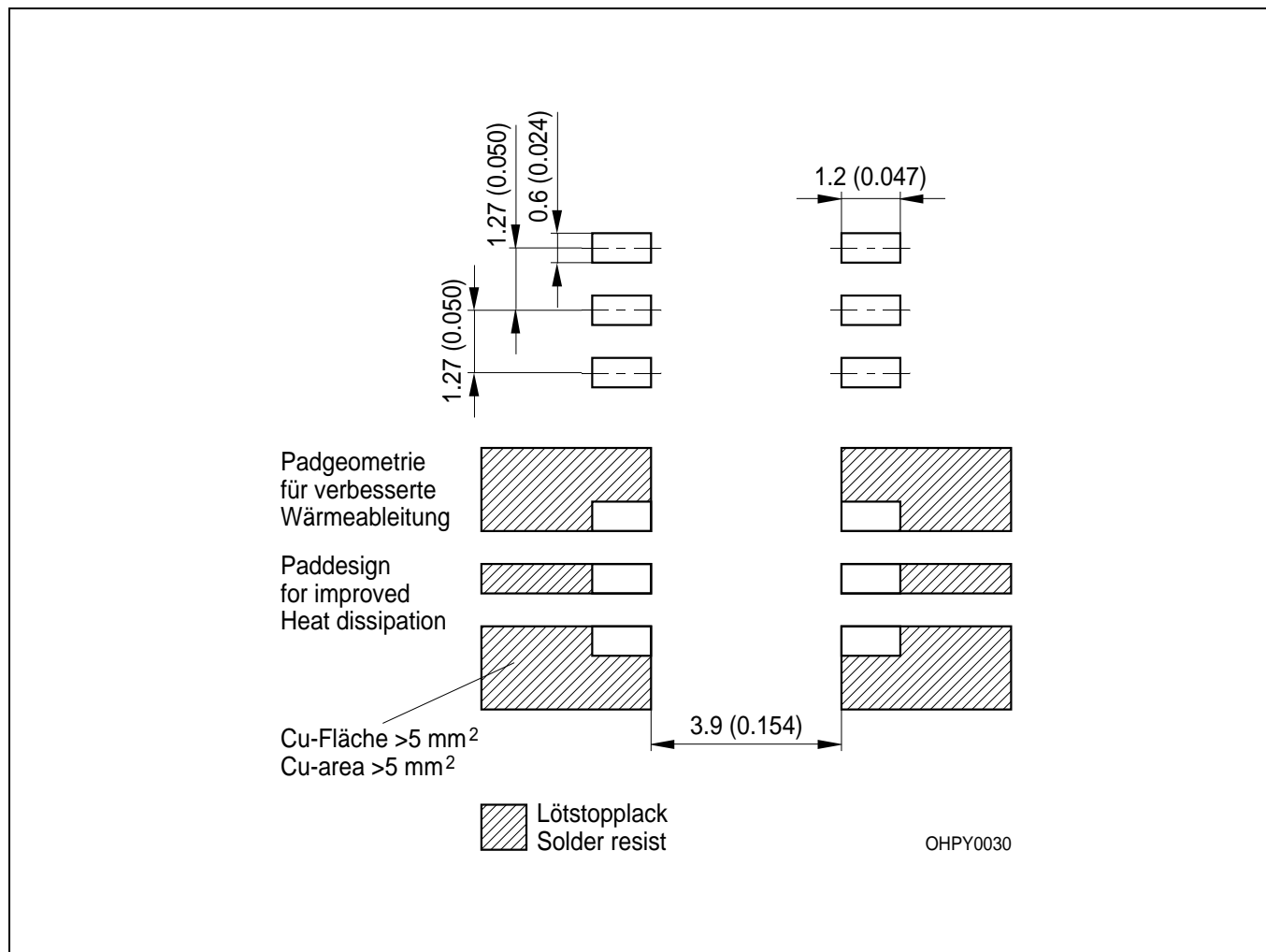


**Maßzeichnung
Package Outlines**



Maße in mm (inch) / Dimensions in mm (inch).

Empfohlenes Lötpaddesign Reflow Löten
Recommended Solder Pad Reflow Soldering



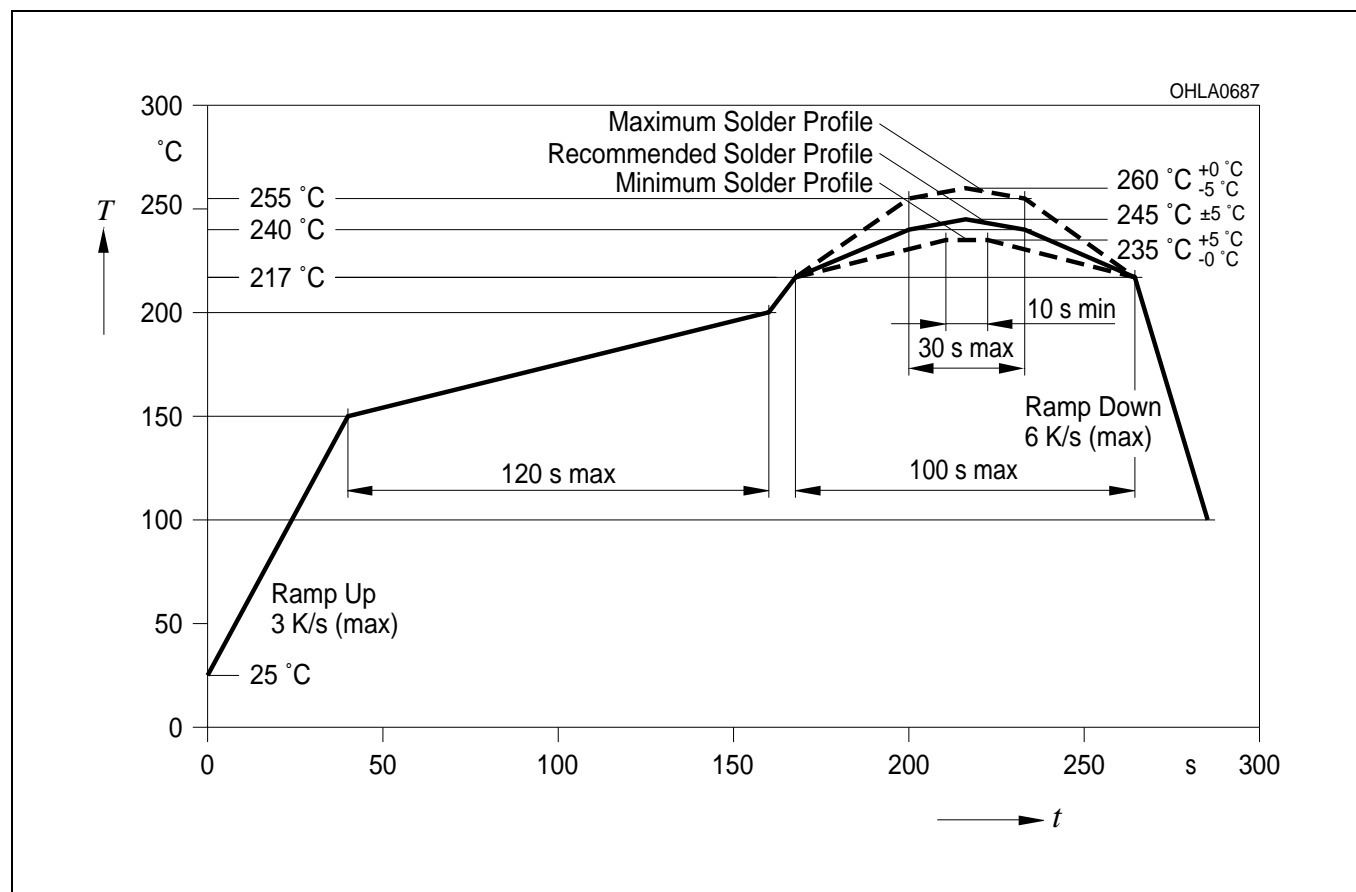
Maße in mm (inch) / Dimensions in mm (inch).

Lötbedingungen Soldering Conditions

Bauform Type	Drypack Level acc. to JEDEC A112-A	Tauch-, Schwalllötung Dip, Wave Soldering		Reflowlötung Reflow Soldering		Kolbenlötung Iron Soldering (Iron temp.)
		Peak Temp. (solderbath)	Max. Time in Peak Zone	Peak Temp. (package temp.)	Max. Time in Peak Zone	
SFH 9240	4	n. a.	–	260 °C	20 sec.	n.a.

Lötbedingungen Soldering Conditions Reflow Lötprofil für bleifreies Löten Reflow Soldering Profile for lead free soldering

Vorbehandlung nach JEDEC Level 4
Preconditioning acc. to JEDEC Level 4
(nach J-STD-020C)
(acc. to J-STD-020C)



Gurtung / Polarität und Lage

siehe Dokument: Short Form Katalog: Gurtung und
Verpackung - SMT-Bauelemente - Gehäuse:SMT RLS

Methode of Taping / Polarity and Orientation see document: Short Form Catalog: Tape and Reel -
SMT-Components - Package: SMT-RLS

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¹ A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or effectiveness of that device or system.

² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered